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AMENDMENTS TO THE CLAIMS

1. (Original) A positive photoresist composition comprising: (A) an alkalisoluble novolak resin in which a portion of hydrogen atoms of all phenolic hydroxyl groups are substituted with 1,2-naphthoquinonediazidesulfonyl groups, and (B) a dissolution promoter comprising at least one compound selected from a group consisting of compounds represented by a general formula (b-1) and a general formula (b-11) shown below:

$$R^{5}$$
 R^{6}
 R^{7}
 R^{8}
 R^{9}
 R^{10}
 R^{10}
 R^{10}
 R^{11}
 R^{15}
 R^{14}
 R^{13}

wherein, R¹ to R⁹ each represent, independently, a hydrogen atom, an alkyl group, a halogen atom, or a hydroxyl group, although at least one of R¹ to R⁹ represents a hydroxyl group; and R¹⁰ to R¹⁵ each represent, independently, a hydrogen atom, an alkyl group, an alkenyl group, a cycloalkyl group or an aryl group;

$$(R^{42})_s$$
 $(HO)_p = (DH)_q$
 $(B^{43})_t$
 $(B^{43})_t$
 $(B^{43})_t$

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wherein, R⁴¹ to R⁴³ each represent, independently, a lower alkyl group, a cycloalkyl group or a lower alkoxy group; p and q each represent an integer from 1 to 3; and r, s and t each represent either 0, or an integer from 1 to 3.

- 2. (Original) A positive photoresist composition according to claim 1, wherein said component (A) is a fractionated resin in which fractionation treatment has been used to reduce a lower molecular weight fraction to no more than 80% by weight of a value prior to said fractionation.
- 3. (Original) A positive photoresist composition according to claim 1, further comprising a photosensitizer (C).
- 4. (Original) A positive photoresist composition according to claim 1, which comprises both (b-1) and (b-11) as dissolution promoters.
- 5. (Currently Amended) A method of forming a resist pattern comprising the steps of applying a positive photoresist composition according to any one of claim 1 through claim 4 to a substrate, conducting a prebake, performing selective exposure, and then performing alkali developing to form said resist pattern.